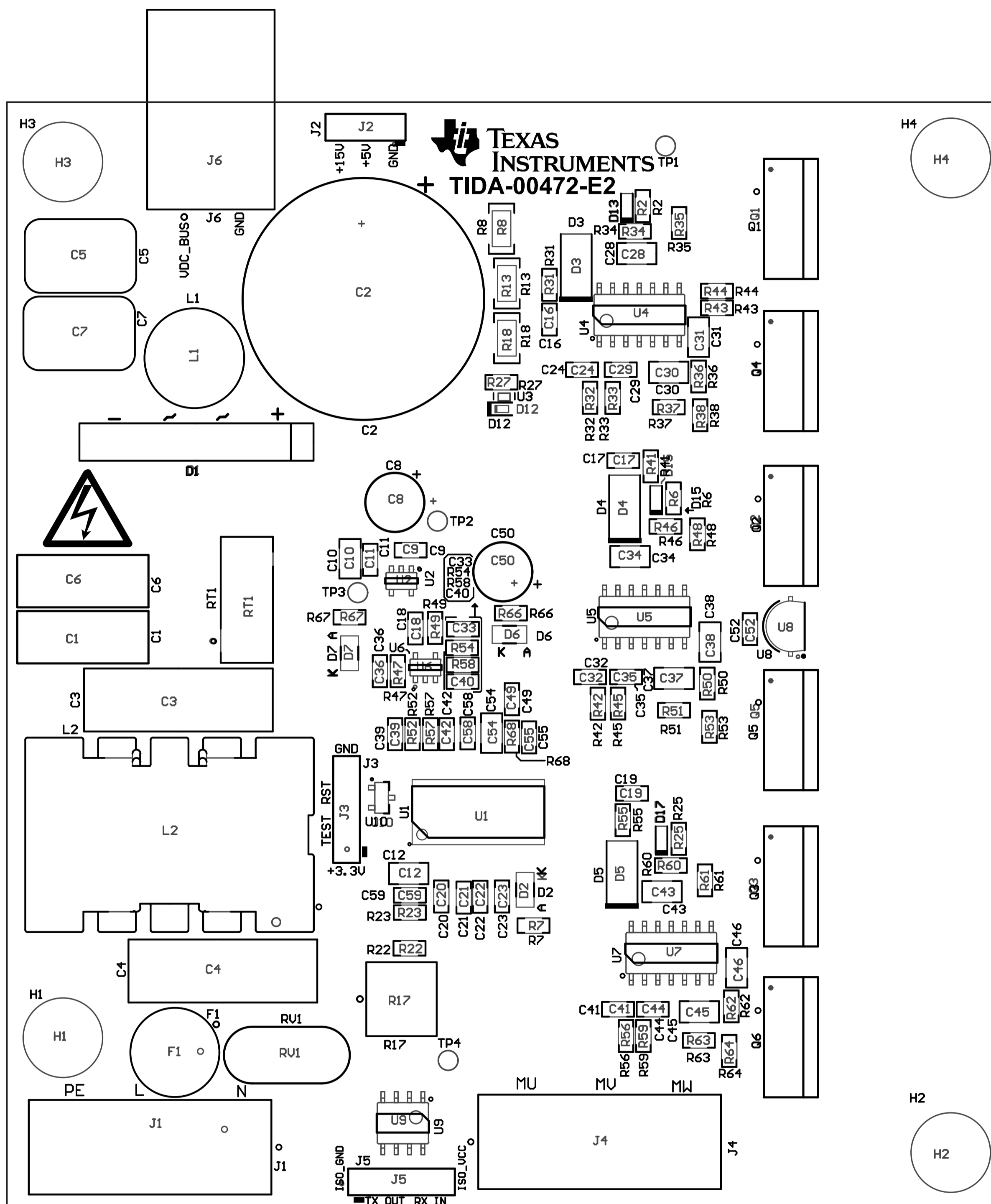


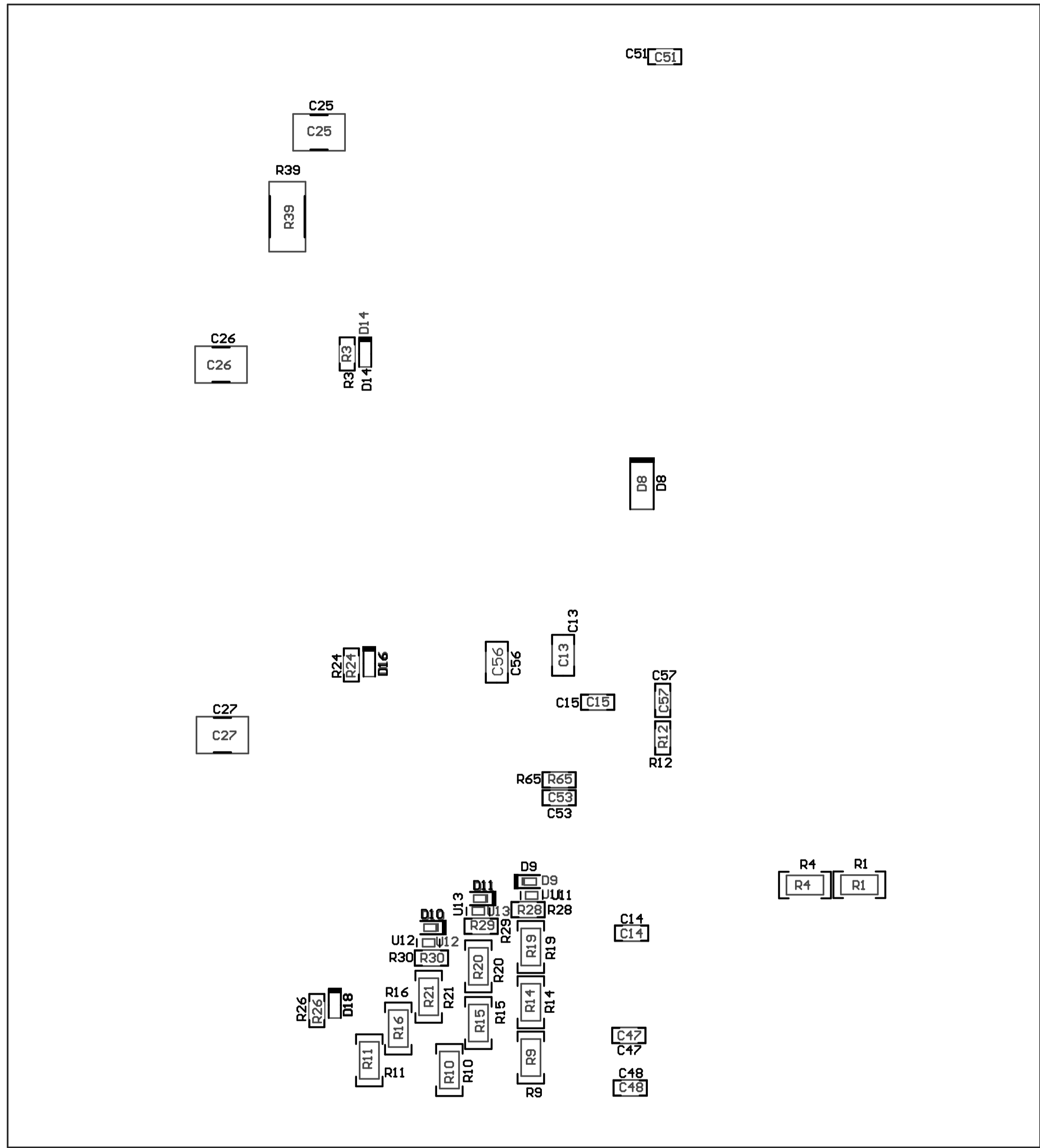
- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

| | | | |
|----------------------------------|-----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00472 | REV: E2 | SUN REV: Not In VersionControl |
| LAYER NAME = M5 Top Overlay | | | |
| Top Layer Assembly Drawing | GENERATED : 9/23/2015 | 7:08:52 PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

| | | | |
|---|-------------------------------|------------|----------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-00472 | REV: E2 | SUN REV: |
| LAYER NAME = M6 Assembly Bottom | Bottom Layer Assembly Drawing | | |
| PLOT NAME = Bottom Layer Assembly Drawing | GENERATED : 9/23/2015 | 7:08:54 PM | |

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